# Specification of Thermoelectric Module TEC1-16115

#### **Description**

The 161 couples, 40mm x 40mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70°C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

#### **Features**

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

#### **Application**

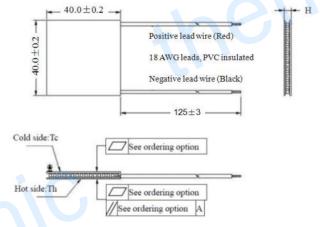
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

#### **Performance Specification Sheet**

Th (°C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>	
DT <sub>max</sub> (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U <sub>max</sub> (Voltage)	20.0	21.6	Voltage applied to the module at DT <sub>max</sub>	
I <sub>max</sub> (Amps)	14.5	14.5	DC current through the modules at DT <sub>max</sub>	
Q <sub>Cmax</sub> (Watts)	186.6	200.9	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (Ohms)	1.05	1.13	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

#### Geometric Characteristics Dimensions in millimeters

## Manufacturing Options



#### A. Solder: B. Sealant:

1. T100: BiSn (Tmelt=138°C)

1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt = 217°C)

2. SS: Silicone sealant

3. T240: SbSn (Tmelt =  $240^{\circ}$ C)

3. EPS: Epoxy sealant

#### C. Ceramics:

#### **D.** Ceramics Surface Options:

1. Alumina (Al<sub>2</sub>O<sub>3</sub>, white 96%)

1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN)

2. Metalized

## **Ordering Option**

Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:3.3± 0.1	0: 0.08/0.08	125±3/Specify
TF	1: 3.3 ± 0.03	1: 0.03/0.03	125±3/Specify

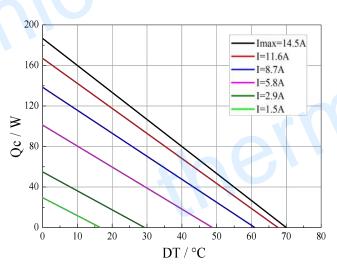
Eg. TF11: Thickness  $3.3\pm0.05$  (mm) and Flatness 0.03/0.03 (mm)

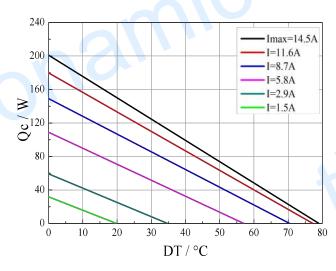
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## **TEC1-16115**

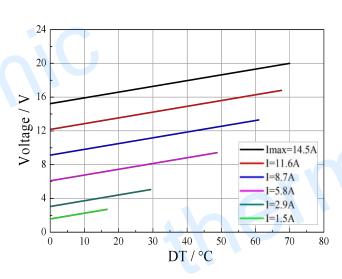
#### Performance Curves at Th=27 °C

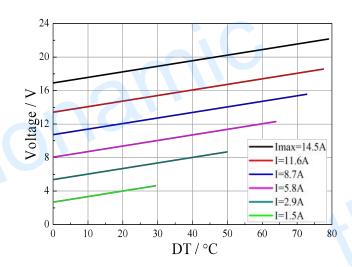
#### Performance Curves at Th=50 °C



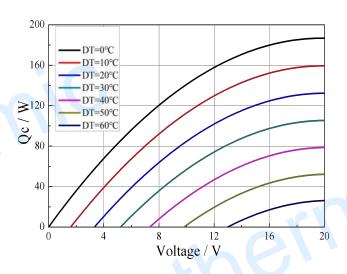


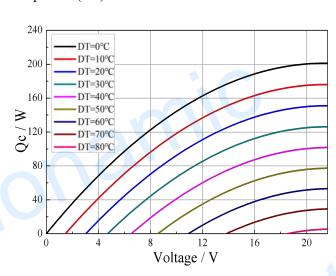
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V= f(DT)





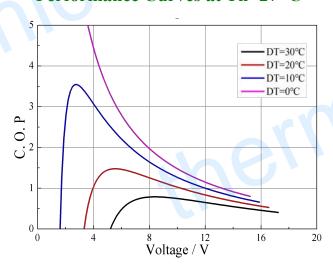
Standard Performance Graph Qc = f(V)

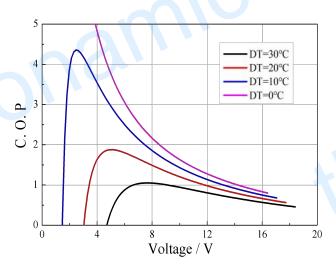
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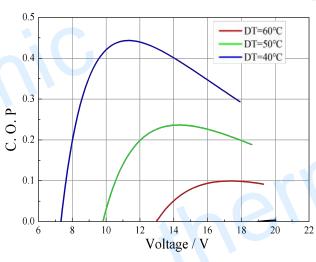
#### Performance Curves at Th=27 °C

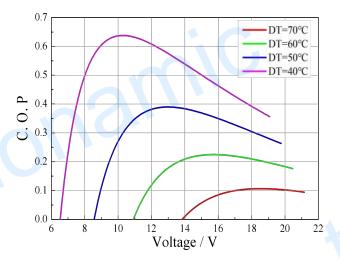
#### Performance Curves at Th=50 °C





Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

**Remark:** The coefficient of performance (COP) is the cooling power Qc/Input power ( $V \times I$ ).

#### **Operation Caution**

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I<sub>max</sub> or V<sub>max</sub>
- Work under DC

Note: All specifications subject to change without notice.